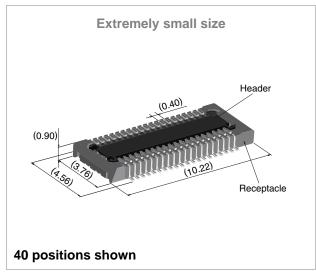
0.4 mm Pitch, 0.9 mm Height, Board-to-Board / Board-to-FPC Connectors

DF30 Series





Overview

Continuous miniaturization and increased component density on PCB created demand for extremely low profile connectors. This series is addition of a new extremely low profile connectors to Hirose's wide range of high reliability board-to-board/board-to-FPC connection solutions.

Features

1. Contact reliability

Concentration of the contact's normal forces at the single point assures good contact wipe and electrical reliability, while confirming the fully mated condition with a definite tactile click.

2. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces the connectors will self align in horizontal axis within 0.3 mm.

3. Automatic board placement

Packaged on tape-and-reel the plug and headers have sufficiently large flat areas to allow pick-up with vacuum nozzles of automatic placement equipment.

4. Variety of contact positions and styles

Available in standard contact positions of: 20, 22, 24, 30, 34, 40, 50, 60, 70 and 80 with and without metal fittings. Addition of metal fittings does not affect external dimensionsof the connectors.

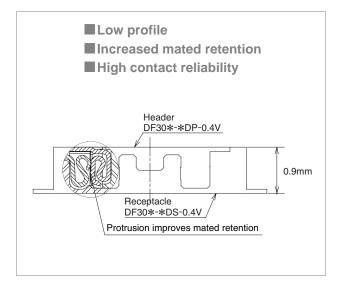
Smaller contact positions are also available.

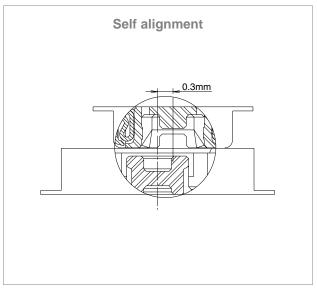
5. Support for continuity test connector

Connectors which have increased insertion and removal durability are available for continuity tests. Contact your Hirose sales representative for details.

Applications

Cellular phones, PDA's, mobile computers, digital cameras, digital video cameras, and other devices demanding high reliability connections in extremely limited spaces.





■Product Specifications

Detin -	Rated current 0.3A	Operating temperature range	: -35°C to 85°C (Note 1)	Storage temperature range	e -10°C to 60°C (Note 2)
Rating	Rated voltage 30V AC	Operating humidity range	: Relative humidity 20% to 80%		Relative humidity 40% to 70% (Note 2)

Item	Specification	Conditions		
1. Insulation resistance	50 MΩ min.	100V DC		
2. Withstanding voltage	No flashover or insulation breakdown.	100V AC / one minute		
3. Contact resistance	100 mΩ max.	100 mA		
4. Vibration	No electrical discontinuity of 1 μ s or more	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours, 3 axis		
5. Humidity	Contact resistance: 100 m Ω max. Insulation resistance: 25 M Ω min.	96 hours at temperature of $40^{\circ}C\pm2^{\circ}C$ and RH of 90% to 95%		
6. Temperature cycle	Contact resistance: 100 m Ω max. Insulation resistance: 50 M Ω min.	Temperature: $-55^{\circ}C \rightarrow +5^{\circ}C$ to $+35^{\circ}C \rightarrow +85^{\circ}C \rightarrow +5^{\circ}C$ to $+35^{\circ}C$ Duration: $30 \rightarrow 10 \rightarrow 30 \rightarrow 10$ (Minutes) 5 cycles		
7. Durability (insertions/withdrawals)	Contact resistance: 100 mΩ max.	50 cycles(Connector for conductivity tests: 500 cycles)		
8. Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350°C for 3 seconds		

Note 1: Includes temperature rise caused by current flow.

■Materials and Finishes

Connectors	Component	Material	Finish	Remarks
Receptacles	Insulator	LCP	Color : Black	UL94V-0
and	Contacts	Phosphor bronze	Gold plated	
Headers	Metal fittings	Phosphor bronze	Tin plated	

■Ordering information

Receptacles and Headers

DF30	FC	*	DS -	0.4	V	(**)
0	2	3	4	6	6	7

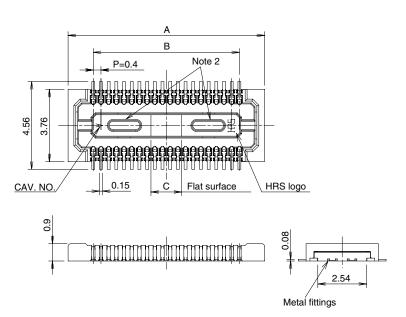
① Series name: DF30	6 Contact pitch: 0.4 mm
Configuration	6 Termination section
FB: With metal fittings, without bosses	V: Straight SMT
FC: Without metal fittings, without bosses	Packaging
CJ: Connector for conductivity tests	(81): Embossed tape packaging (5,000 pieces per reel)
(3) Number of positions: 20, 22, 24, 30, 34, 40, 50, 60, 70, 80	(82): Embossed tape packaging (1,000 pieces per reel)
4 Connector type	
DS: Double row receptacle	
DP: Double row header	

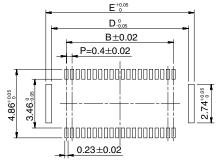
Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

Note 3: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

■Receptacles (with metal fittings)







Recommended solder paste thickness: 120 μ m

[Specification number -**, (**)

(81): Embossed tape packaging (5,000 pieces per reel)

(82): Embossed tape packaging (1,000 pieces per reel)

Unit: mm

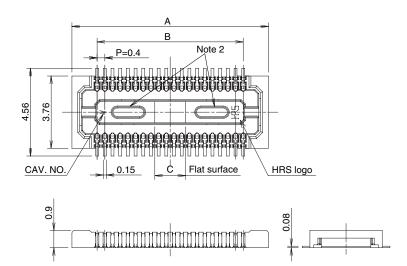
Part Number	CL No.	Number of contacts	А	В	С	D	Е	RoHS
DF30FB-20DS-0.4V(**)	CL684-1098-3-**	20	6.22	3.6	1.2	5.72	6.52	
DF30FB-22DS-0.4V(**)	CL684-1099-6-**	22	6.62	4.0	1.2	6.12	6.92	
DF30FB-24DS-0.4V(**)	CL684-1100-3-**	24	7.02	4.4	1.2	6.52	7.32	
DF30FB-30DS-0.4V(**)	CL684-1101-6-**	30	8.22	5.6	1.2	7.72	8.52	
DF30FB-34DS-0.4V(**)	CL684-1102-9-**	34	9.02	6.4	1.36	8.52	9.32	\
DF30FB-40DS-0.4V(**)	CL684-1103-1-**	40	10.22	7.6	1.6	9.72	10.52	⊢ YES
DF30FB-50DS-0.4V(**)	CL684-1104-4-**	50	12.22	9.6	2.0	11.72	12.52	
DF30FB-60DS-0.4V(**)	CL684-1105-7-**	60	14.22	11.6	2.4	13.72	14.52	
DF30FB-70DS-0.4V(**)	CL684-1106-0-**	70	16.22	13.6	2.8	15.72	16.52	
DF30FB-80DS-0.4V(**)	CL684-1107-2-**	80	18.22	15.6	3.2	17.72	18.52	

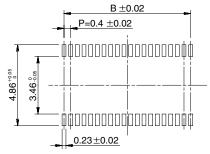
Note 1: Order by number of reels.

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

■ Receptacles (without metal fittings)







Recommended solder paste thickness: 120 μ m

[Specification number] -**, (**)

(81): Embossed tape packaging (5,000 pieces per reel)

(82): Embossed tape packaging (1,000 pieces per reel)

Unit: mm

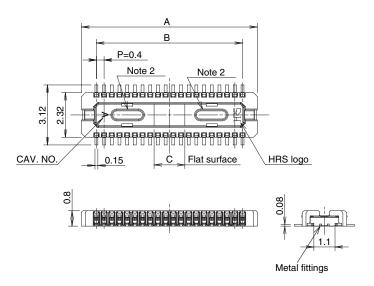
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Part Number	CL No.	Number of contacts	Α	В	С	RoHS
DF30FC-20DS-0.4V(**)	CL684-1109-8-**	20	6.22	3.6	1.2	
DF30FC-22DS-0.4V(**)	CL684-1110-7-**	22	6.62	4.0	1.2	
DF30FC-24DS-0.4V(**)	CL684-1111-0-**	24	7.02	4.4	1.2	
DF30FC-30DS-0.4V(**)	CL684-1112-2-**	30	8.22	5.6	1.2	
DF30FC-34DS-0.4V(**)	CL684-1113-5-**	34	9.02	6.4	1.36	YES
DF30FC-40DS-0.4V(**)	CL684-1078-6-**	40	10.22	7.6	1.6	TES
DF30FC-50DS-0.4V(**)	CL684-1114-8-**	50	12.22	9.6	2.0	
DF30FC-60DS-0.4V(**)	CL684-1082-3-**	60	14.22	11.6	2.4	
DF30FC-70DS-0.4V(**)	CL684-1115-0-**	70	16.22	13.6	2.8	
DF30FC-80DS-0.4V(**)	CL684-1116-3-**	80	18.22	15.6	3.2	

Note 1: Order by number of reels.

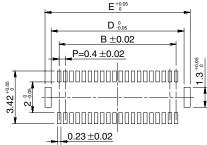
Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

■Header (with metal fittings)





●Recommended PCB mounting pattern



Recommended solder paste thickness: 120 μ m

[Specification number -**, (**)

(81): Embossed tape packaging (5,000 pieces per reel)

(82): Embossed tape packaging (1,000 pieces per reel)

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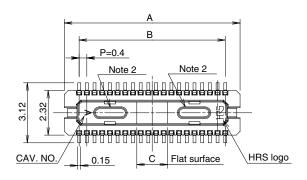
Part Number	CL No.	Number of contacts	А	В	С	D	Е	RoHS
DF30FB-20DP-0.4V(**)	CL684-1129-5-**	20	5.14	3.6	1.2	4.64	5.44	
DF30FB-22DP-0.4V(**)	CL684-1130-4-**	22	5.54	4.0	1.2	5.04	5.84]
DF30FB-24DP-0.4V(**)	CL684-1131-7-**	24	5.94	4.4	1.2	5.44	6.24]
DF30FB-30DP-0.4V(**)	CL684-1132-0-**	30	7.14	5.6	1.2	6.64	7.44	
DF30FB-34DP-0.4V(**)	CL684-1133-2-**	34	7.94	6.4	1.36	7.44	8.24	YES
DF30FB-40DP-0.4V(**)	CL684-1134-5-**	40	9.14	7.6	1.6	8.64	9.44	163
DF30FB-50DP-0.4V(**)	CL684-1135-8-**	50	11.14	9.6	2.0	10.64	11.44	
DF30FB-60DP-0.4V(**)	CL684-1074-5-**	60	13.14	11.6	2.4	12.64	13.44	
DF30FB-70DP-0.4V(**)	CL684-1075-8-**	70	15.14	13.6	2.8	14.64	15.44	
DF30FB-80DP-0.4V(**)	CL684-1136-0-**	80	17.14	15.6	3.2	16.64	17.44	

Note 1: Order by number of reels.

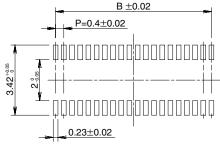
Note 2: Headers with 24 or fewer contacts positions will not have protruding areas.

■Header (without metal fittings)









Recommended solder paste thickness: 120 μm

[Specification number] -**, (**)

(81): Embossed tape packaging (5,000 pieces per reel)

(82): Embossed tape packaging (1,000 pieces per reel)

Unit: mm

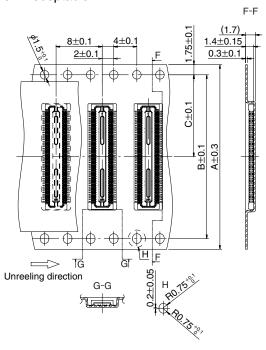
Part Number	CL No.	Number of contacts	Α	В	С	RoHS
DF30FC-20DP-0.4V(**)	CL684-1138-6-**	20	5.14	3.6	1.2	
DF30FC-22DP-0.4V(**)	CL684-1139-9-**	22	5.54	4.0	1.2	
DF30FC-24DP-0.4V(**)	CL684-1140-8-**	24	5.94	4.4	1.2	
DF30FC-30DP-0.4V(**)	CL684-1141-0-**	30	7.14	5.6	1.2	
DF30FC-34DP-0.4V(**)	CL684-1142-3-**	34	7.94	6.4	1.36	YES
DF30FC-40DP-0.4V(**)	CL684-1079-9-**	40	9.14	7.6	1.6	TES
DF30FC-50DP-0.4V(**)	CL684-1143-6-**	50	11.14	9.6	2.0	
DF30FC-60DP-0.4V(**)	CL684-1083-6-**	60	13.14	11.6	2.4	
DF30FC-70DP-0.4V(**)	CL684-1077-3-**	70	15.14	13.6	2.8	
DF30FC-80DP-0.4V(**)	CL684-1144-9-**	80	17.14	15.6	3.2	

Note 1: Order by number of reels.

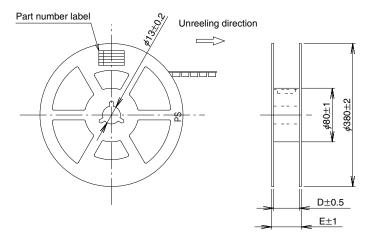
Note 2: Headers with 24 or fewer contacts positions will not have protruding areas.

▶ Packaging Specification

• Embossed Carrier Tape Dimensions - Receptacle



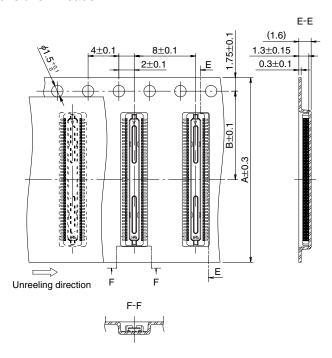
Reel Dimensions



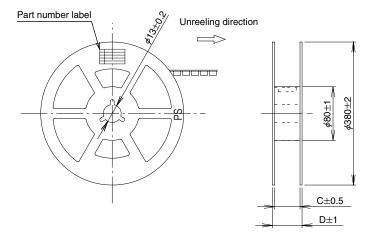
					Unit: mm
Part Number	Α	В	С	D	E
DF30#-20DS-0.4V(**)	16.0	_	7.5	17.5	21.5
DF30#-22DS-0.4V(**)	16.0	_	7.5	17.5	21.5
DF30#-24DS-0.4V(**)	16.0	_	7.5	17.5	21.5
DF30#-30DS-0.4V(**)	16.0	_	7.5	17.5	21.5
DF30#-34DS-0.4V(**)	16.0	_	7.5	17.5	21.5
DF30#-40DS-0.4V(**)	24.0	_	11.5	25.5	29.5
DF30#-50DS-0.4V(**)	24.0	_	11.5	25.5	29.5
DF30#-60DS-0.4V(**)	24.0	_	11.5	25.5	29.5
DF30#-70DS-0.4V(**)	24.0	_	11.5	25.5	29.5
DF30#-80DS-0.4V(**)	32.0	28.4	14.2	33.5	37.5

Embossed tape 32mm or wider will have perforated feed holes on two sides.

Embossed Carrier Tape Dimensions - Header



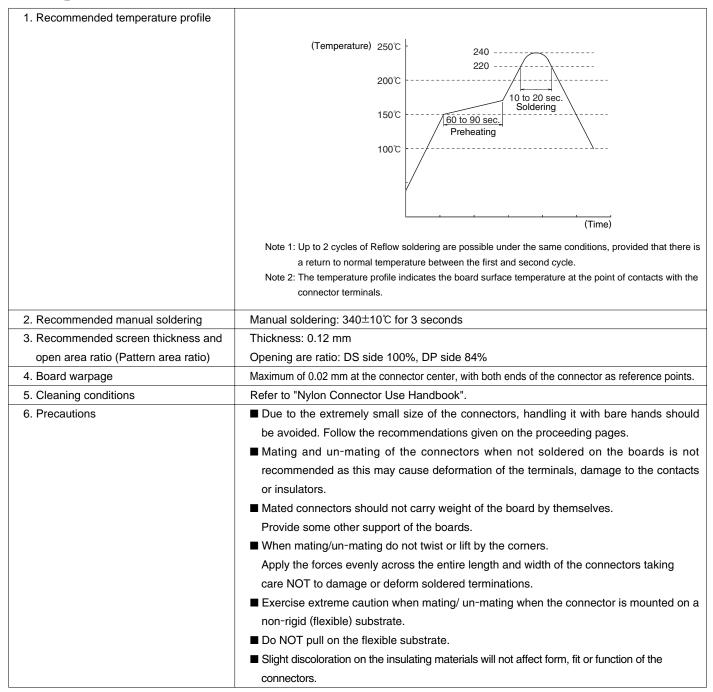
Reel Dimensions



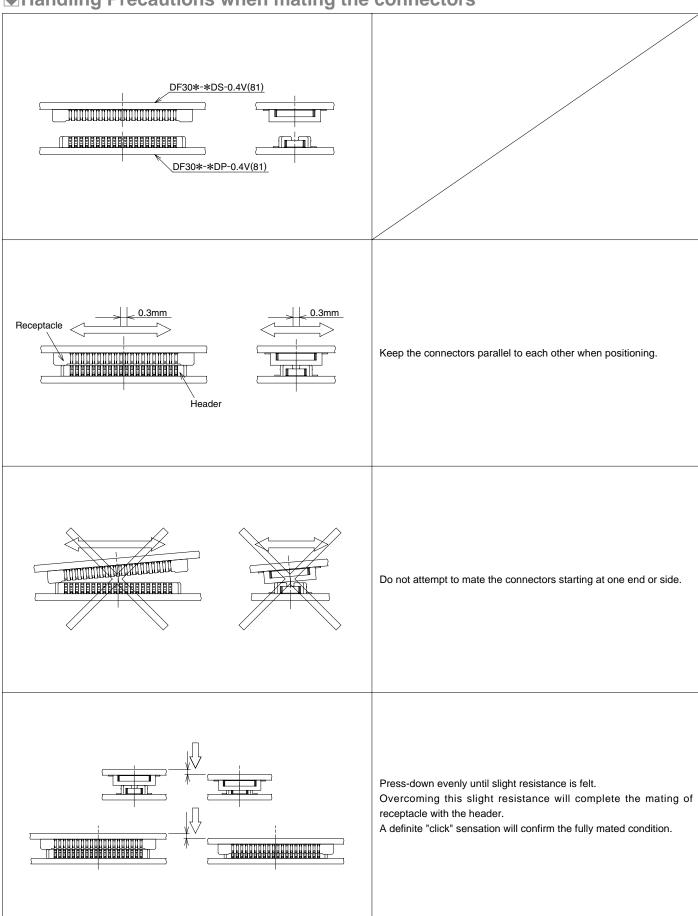
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Part Number	Α	В	С	D
DF30#-20DP-0.4V(**)	16.0	7.5	17.5	21.5
DF30#-22DP-0.4V(**)	16.0	7.5	17.5	21.5
DF30#-24DP-0.4V(**)	16.0	7.5	17.5	21.5
DF30#-30DP-0.4V(**)	16.0	7.5	17.5	21.5
DF30#-34DP-0.4V(**)	16.0	7.5	17.5	21.5
DF30#-40DP-0.4V(**)	16.0	7.5	17.5	21.5
DF30#-50DP-0.4V(**)	24.0	11.5	25.5	29.5
DF30#-60DP-0.4V(**)	24.0	11.5	25.5	29.5
DF30#-70DP-0.4V(**)	24.0	11.5	25.5	29.5
DF30#-80DP-0.4V(**)	24.0	11.5	25.5	29.5

●Usage Recommendations



● Handling Precautions when mating the connectors



● Handling Precautions when un-mating the connectors

